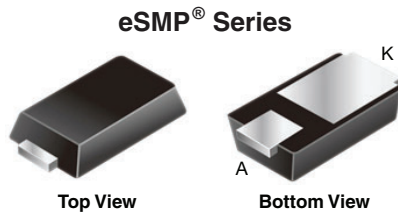


Surface-Mount Schottky Barrier Rectifiers


MicroSMP (DO-219AD)

Anode Cathode

FEATURES

- Very low profile - typical height of 0.65 mm
- Ideal for automated placement
- Low forward voltage drop, low power losses
- High efficiency
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
- Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

 AUTOMOTIVE
GRADE
Available

RoHS
COMPLIANT
HALOGEN
FREE

LINKS TO ADDITIONAL RESOURCES


[3D Models](#)

PRIMARY CHARACTERISTICS

| | |
|------------------------|---------------------|
| $I_{F(AV)}$ | 2.0 A |
| V_{RRM} | 20 V, 30 V |
| I_{FSM} | 30 A |
| V_F at $I_F = 2.0$ A | 0.47 V |
| T_J max. | 150 °C |
| Package | MicroSMP (DO-219AD) |
| Circuit configuration | Single |

TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

MECHANICAL DATA

Case: MicroSMP (DO-219AD)

Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified
("X" denotes revision code e.g. A, B,...)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)

| PARAMETER | SYMBOL | MSS2P2 | MSS2P3 | UNIT |
|--|----------------|-------------|--------|------|
| Device marking code | | 22 | 23 | |
| Maximum repetitive peak reverse voltage | V_{RRM} | 20 | 30 | V |
| Maximum average forward rectified current (fig. 1) | $I_{F(AV)}$ | 2.0 | | A |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | I_{FSM} | 30 | | A |
| Operating junction and storage temperature range | T_J, T_{STG} | -55 to +150 | | °C |



| ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | |
|--|------------------------|-------------------------|-------------------------------|------|------|------|
| PARAMETER | TEST CONDITIONS | | SYMBOL | TYP. | MAX. | UNIT |
| Maximum instantaneous forward voltage | I _F = 1.0 A | T _A = 25 °C | V _F ⁽¹⁾ | 0.44 | - | V |
| | I _F = 2.0 A | | | 0.52 | 0.60 | |
| | I _F = 1.0 A | T _A = 125 °C | | 0.36 | - | |
| | I _F = 2.0 A | | | 0.47 | 0.55 | |
| Maximum reverse current | Rated V _R | T _A = 25 °C | I _R ⁽²⁾ | 15 | 250 | μA |
| | | T _A = 125 °C | | 6.0 | 20 | mA |
| Typical junction capacitance | 4.0 V, 1 MHz | | C _J | 65 | - | pF |

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
- (2) Pulse test: Pulse width ≤ 40 ms

| THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | |
|---|---------------------------------|--------|--------|------|
| PARAMETER | SYMBOL | MSS2P2 | MSS2P3 | UNIT |
| Typical thermal resistance | R _{θJA} ⁽¹⁾ | 105 | | °C/W |
| | R _{θJL} ⁽¹⁾ | 15 | | |
| | R _{θJC} ⁽¹⁾ | 20 | | |

Note

- (1) Thermal resistance from junction to ambient and junction to lead mounted on PCB with 6.0 mm x 6.0 mm copper pad areas R_{θJL} is measured at the terminal of cathode band. R_{θJC} is measured at the top center of the body

| ORDERING INFORMATION (Example) | | | | |
|--------------------------------|-----------------|------------------------|---------------|-----------------------------------|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE |
| MSS2P3-M3/89A | 0.006 | 89A | 4500 | 7" diameter plastic tape and reel |
| MSS2P3HM3_A/H ⁽¹⁾ | 0.006 | H | 4500 | 7" diameter plastic tape and reel |

Note

- (1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

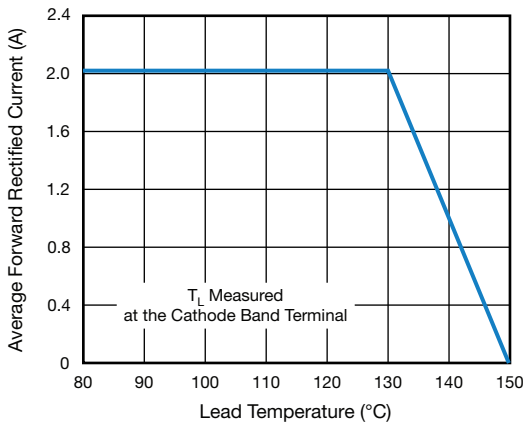


Fig. 1 - Maximum Forward Current Derating Curve

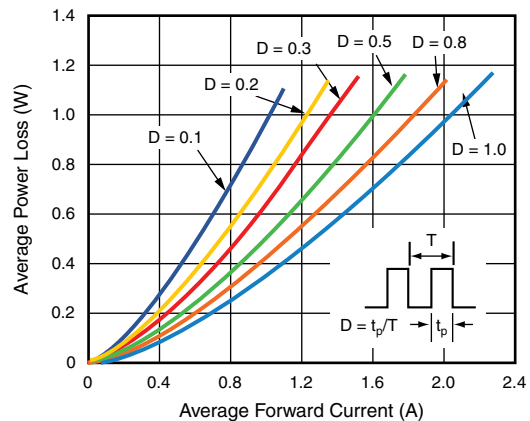


Fig. 2 - Forward Power Loss Characteristics

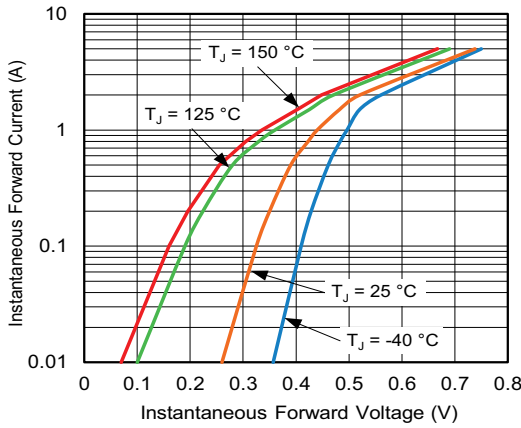


Fig. 3 - Typical Instantaneous Forward Characteristics

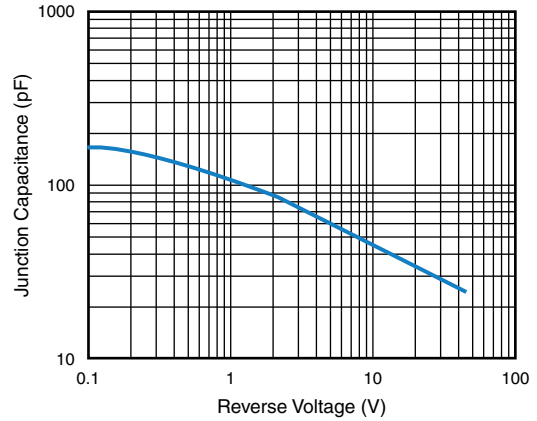


Fig. 5 - Typical Junction Capacitance

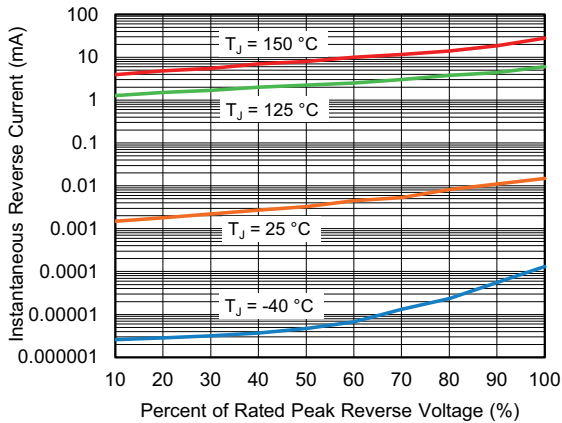


Fig. 4 - Typical Reverse Characteristics

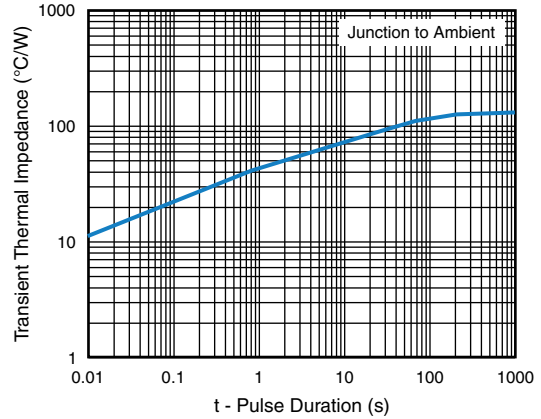
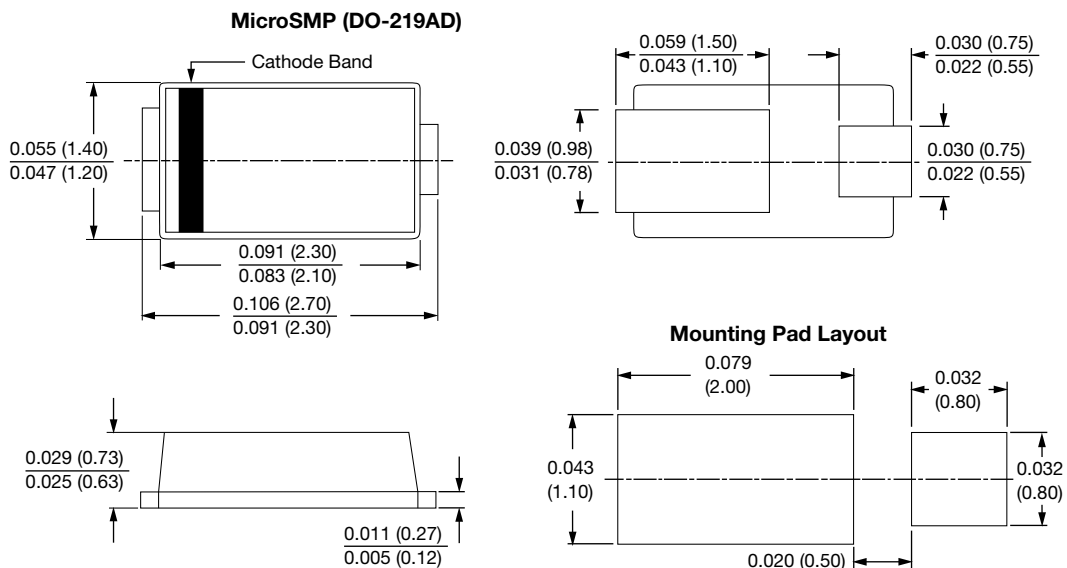


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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